

DATE: 04/16/2024

PCN #: 2680

PCN Title: Qualified Bill of Material (BOM) – Cu Pillar Bump Optimization

Dear Customer:

This is an announcement of change(s) to products that are currently being offered by Diodes Incorporated.

We request that you acknowledge receipt of this notification within 30 days of the date of this PCN. If you require samples for evaluation purposes, please make a request within 30 days as well. Otherwise, samples may not be built prior to this change. Please refer to the implementation date of this change as it is stated in the attached PCN form. Please contact your local Diodes sales representative to acknowledge receipt of this PCN and for any sample requests.

The changes announced in this PCN will not be implemented earlier than 90 days from the notification date stated in the attached PCN form.

Previously agreed upon customer specific change process requirements or device specific requirements will be addressed separately.

For questions or clarification regarding this PCN, please contact your local Diodes sales representative.

Sincerely,

Diodes Incorporated PCN Team



PRODUCT CHANGE NOTICE

PCN-2680 REV 1

Notification Date:	Implementation Date:	Product Family:	Change Type:	PCN #:
04/16/2024	07/15/2024	Analog	Cu Pillar Bump Optimization	2680
TITLE				
Qualified Bill of Material (BOM) - Cu Pillar Bump Optimization.				
DESCRIPTION OF CHANGE				
<p>This PCN is being issued to notify customers that in order to assure continuity of supply, Diodes Incorporated has qualified Bill of Material (BOM), Cu Pillar Bump Optimization from Internal A/T Site (CAT) located in Chengdu, China.</p> <p>Full electrical characterization and high reliability testing have been completed on representative part numbers to ensure no change to device functionality or electrical specifications in the datasheet.</p>				
IMPACT				
Continuity of Supply. There will be no change to the Form, Fit or Function of products affected.				
PRODUCTS AFFECTED				
Table 1 - Bill Of Material (BOM) - Cu Pillar Bump Optimization				
WEB LINKS				
Manufacturer's Notice:	https://www.diodes.com/quality/product-change-notices/diodes-product-change-notices/			
For More Information Contact:	https://www.diodes.com/about/contact-us/contact-sales/			
Data Sheet:	https://www.diodes.com/catalog/			
DISCLAIMER				
Unless a Diodes Incorporated Sales representative is contacted in writing within 30 days of the posting of this notice, all changes described in this announcement are considered approved.				

Table 1 - Bill Of Material (BOM) - Cu Pillar Bump Optimization

AP62250WU-7	AP62300TWU-7	AP62300WU-7	AP62301WU-7		
-------------	--------------	-------------	-------------	--	--